

-- GIGABYTE Showcases Latest USB 3.0 Motherboards at CeBIT 2010 --

-- Leading Technologies to Power the High Speed Data Transfer Revolution --

Hannover, Germany March 02, 2010 - GIGABYTE TECHNOLOGY Co., Ltd, a leading manufacturer of motherboards, graphics cards and other computing hardware solutions today proudly announce their motherboard line-up for CeBIT 2010, highlighting their industry-leading USB 3.0 motherboards for both the Intel and AMD platforms.

On the Intel Platform, GIGABYTE will be demoing their flagship P55 motherboard, the GIGABYTE [GA-P55A-UD7](#). Delivering awesome features for power users and gaming enthusiasts including a 24 phase power design, NVIDIA® **3-Way SLI™**/ATI® **CrossFireX™**, as well as support for **USB 3.0**, **3x USB Power Boost** (unique to GIGABYTE), and **SATA 3.0 (6Gbps)**, the GIGABYTE GA-P55A-UD7 is the all new performance and feature leader of its class.

The extreme bandwidth required for 3-Way SLI™ capability is made possible by an onboard **NVIDIA NF200** chip that allows the P55A-UD7 to deliver the ultimate in graphics performance for gaming enthusiasts who demand the highest frame rates without compromising on resolution. Additional bandwidth is provided by [GIGABYTE 333 Onboard Acceleration](#) with onboard [SuperSpeed USB 3.0](#) and Serial ATA 6Gbps from NEC® and Marvell®, providing the P55A-UD7 with an incredible amount of graphics and data bandwidth at any given time.

In conjunction with AMD's upcoming launch of the 800 Series chipsets, GIGABYTE will also showcase the soon to be released GA-890GPA-UD3H motherboard, featuring the **AMD 890GX chipset** paired with the all new **SB850** South Bridge, offering up native support for Serial ATA 6Gbps and RAID 0, 1, 5 and 10. Also equipped with GIGABYTE [3x USB Power Boost](#) and **USB 3.0** support by utilizing the industry-leading NEC® controller, the GIGABYTE GA-890GPA-UD3H ensures users are ready to take advantage the next wave of high speed data transfer and storage technologies.

The GIGABYTE GA-890GPA-UD3H also features the integrated ATI **Radeon™ HD 4290** graphics core (**DirectX 10.1**) and **128M DDR3 sideport** memory, allowing for easy overclock of the default 700MHz GPU clock up to **1150MHz** for a **3DMark06 score of 3300** or above, which is **18% higher** than the previous generation AMD 790GX chipset. The graphics potential of the board is further extended with the addition of **two PCI-E 2.0 x16** graphics slots, allowing users to run ATI **CrossFireX™** (running at x8,x8), or a single card at x16 including the next generation DirectX 11 graphics cards for some ATI **Hybrid CrossFireX™** action, providing an enhanced level of gaming performance, productivity and platform power efficiency.

GIGABYTE Motherboards to be Showcased at CeBIT 2010

Intel Platform	AMD Platform
GA-X58A-UD7 (featuring USB 3.0)	GA-890GPA-UD3H (featuring USB 3.0)
GA-X58A-UD5 (featuring USB 3.0)	GA-790XT-USB3 (featuring USB 3.0)
GA-X58A-UD3R (featuring USB 3.0)	
GA-P55A-UD7 (featuring USB 3.0)	
GA-P55A-UD5 (featuring USB 3.0)	
GA-P55A-UD3P (featuring USB 3.0)	
GA-P55-USB3 (featuring USB 3.0)	
GA-H55M-USB3 (featuring USB 3.0)	
GA-H55M-USB3L (featuring USB 3.0)	
GA-EP43T-USB3 (featuring USB 3.0)	

GIGABYTE will demonstrate their market leading USB 3.0 solutions at the **GIGABYTE Booth: H17, E54**. To reserve a private meeting, please contact your GIGABYTE representative.

Featured Technologies on GIGABYTE USB 3.0 Motherboards:

USB 3.0 Support



GIGABYTE USB 3.0 motherboards support the latest generation SuperSpeed USB 3.0 technology made possible through an onboard NEC uPD720200 host controller. With superfast transfer rates of up to 5 Gbps, users are able to experience an almost 10x improvement over USB 2.0. Additionally, backwards compatibility with USB 2.0 assures users of long term use of their legacy USB 2.0 devices. The onboard NEC SuperSpeed USB 3.0 technology also provides new power management features that include increased maximum bus power and device current draw to better accommodate

power-hungry devices.

3x USB Power Boost



GIGABYTE **USB 3.0 motherboards** feature a 3x USB power boost, delivering greater compatibility and extra power for USB devices. GIGABYTE's unique USB power design is also able to efficiently regulate output over the full voltage range, which greatly enhances USB device compatibility. In addition, dedicated lower resistance fuses ensure lower voltage drops, and provide more stable and plentiful power delivery.

** Available features vary by model. Please visit the [GIGABYTE website](http://www.gigabyte.com) to see a complete listing of motherboard model features.*

For additional information about the GIGABYTE USB 3.0 motherboards and their flagship UD7-series, please visit the GIGABYTE website at: http://www.gigabyte.com.tw/FileList/WebPage/mb_usb3mb/default.htm and http://www.gigabyte.com.tw/FileList/WebPage/mb_ud7/ud7.htm.

About GIGABYTE *Upgrade Your Life*

GIGABYTE, headquartered in Taipei, Taiwan, is known as a global leading brand in the IT industry, with employees and business channels in almost every country. Founded in 1986, GIGABYTE started as a research and development team and has since taken the lead in the world's motherboard market. On top of motherboards and graphics accelerators, GIGABYTE further expanded its product portfolio to include notebook and desktop PCs, digital home entertainment appliances, networking servers, communications, mobile and handheld devices, servicing every facet of people's lives at home or business. Everyday GIGABYTE aims to "Upgrade Your Life" with the most innovative designs and impeccable quality and services. Visit www.gigabyte.com.tw for more information.